

FDP51N25 / FDPF51N25 N-Channel UniFETTM MOSFET 250 V, 51 A, 60 mΩ

Features

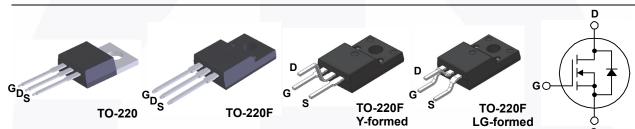
- $R_{DS(on)} = 48 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 25.5 \text{ A}$
- Low Gate Charge (Typ. 55 nC)
- Low C_{rss} (Typ. 63 pF)

Applications

- PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Para	ımeter	FDP51N25	FDPF51N25 FDPF51N25YDTU FDPF51N25RDTU	Unit
V _{DSS}	Drain-Source Voltage		250		V
I _D	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)	51 30	51* 30*	
I _{DM}	Drain Current	- Pulsed (Note 1)	204	204*	А
V _{GSS}	Gate-Source voltage		± 30		V
E _{AS}	Single Pulsed Avalanche Energy (Note		·	mJ	
I _{AR}	Avalanche Current	(Note 1)	51		А
E _{AR}	Repetitive Avalanche Energy (Note 1		32		mJ
dv/dt	Peak Diode Recovery dv/dt (No		4.5		V/ns
P _D	Power Dissipation	(T _C = 25°C) - Derate Above 25°C	320 3.7	38 0.3	W W/∘C
T _{J,} T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C
TL	Maximum Lead Temperature 1/8" from Case for 5 Seconds		:	°C	

*Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FDP51N25	FDPF51N25 FDPF51N25YDTU FDPF51N25RDTU	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.39	3.3	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDP51N25	FDP51N25	TO-220	Tube	N/A	N/A	50 units
FDPF51N25	FDPF51N25	TO-220F	Tube	N/A	N/A	50 units
FDPF51N25YDTU	FDPF51N25	TO-220F (Y-formed)	Tube	N/A	N/A	50 units
FDPF51N25RDTU	FDPF51N25	TO-220F (LG-formed)	Tube	N/A	N/A	50 units

Electrical Characteristics $T_{C} = 25^{\circ}C$ unless otherwise noted.

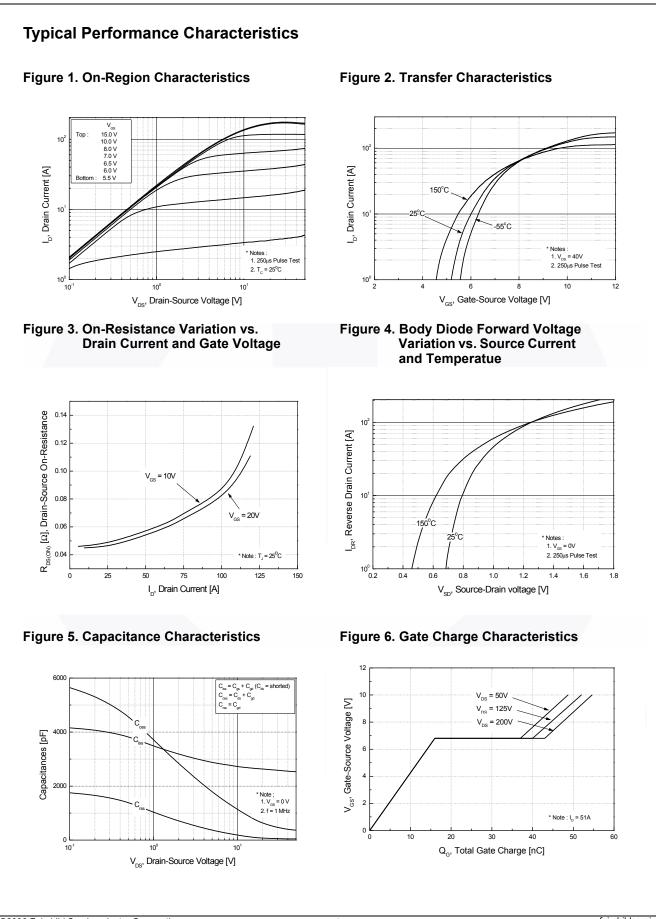
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_{D} = 250 μ A, T_{J} = 25 °C	250			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		0.25		V/∘C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 250 V, V_{GS} = 0 V$ $V_{DS} = 200 V, T_{C} = 125^{\circ}C$			1 10	μΑ μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0V			-100	nA
On Charac	teristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 25.5 A	-	0.048	0.060	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 25.5 A		43		S
Dynamic C	Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		2620	3410	pF
C _{oss}	Output Capacitance			530	690	pF
C _{rss}	Reverse Transfer Capacitance			63	90	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V_{DD} = 125 V, I _D = 51 A, V_{GS} = 10 V, R _G = 25 Ω (Note 4)		62	135	ns
t _r	Turn-On Rise Time			465	940	ns
t _{d(off)}	Turn-Off Delay Time			98	205	ns
t _f	Turn-Off Fall Time			130	270	ns
Qg	Total Gate Charge	V _{DS} = 200 V, I _D = 51 A,		55	70	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V (Note 4)		16		nC
Q _{gd}	Gate-Drain Charge			27		nC
Drain-Sou	rce Diode Characteristics and Maximur	n Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				51	А
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				204	А
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 51 A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 51 A,		178		ns
Q _{rr}	Reverse Recovery Charge	dl _F /dt =100 A/μs		4.0		μC

Notes:

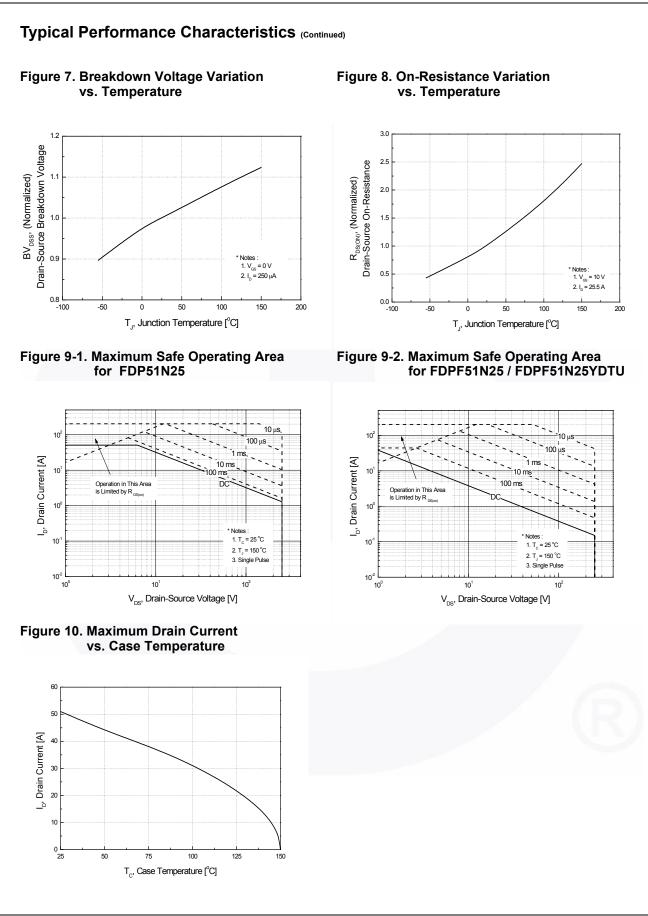
1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. L = 0.68 mH, I_{AS} = 51 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C.

3. $I_{SD} \le 51$ A, di/dt ≤ 200 A/µs, $V_{DD} \le BV_{DSS}$, starting $T_J = 25^{\circ}C$. 4. Essentially independent of operating temperature typical characteristics.

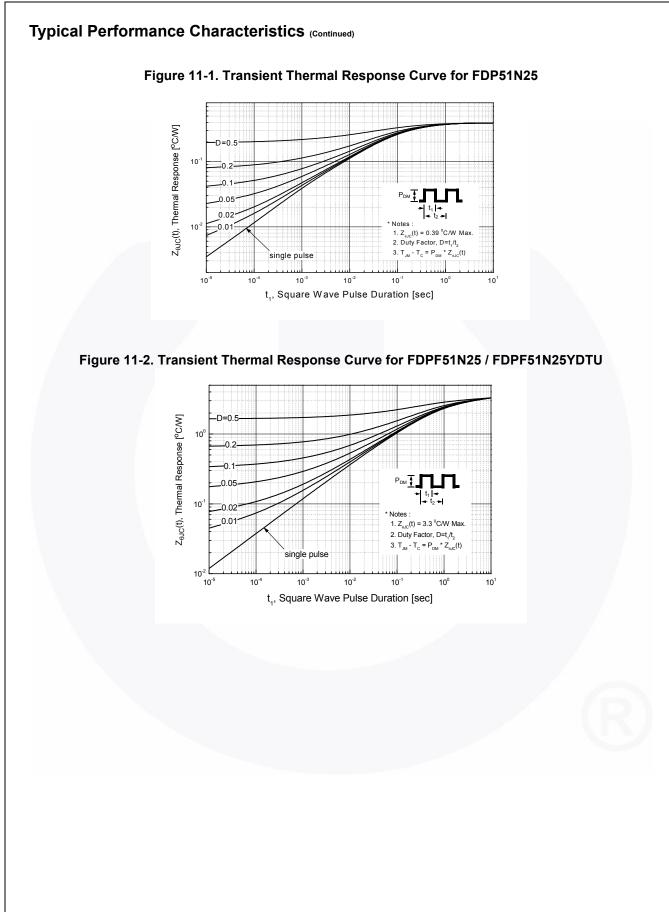


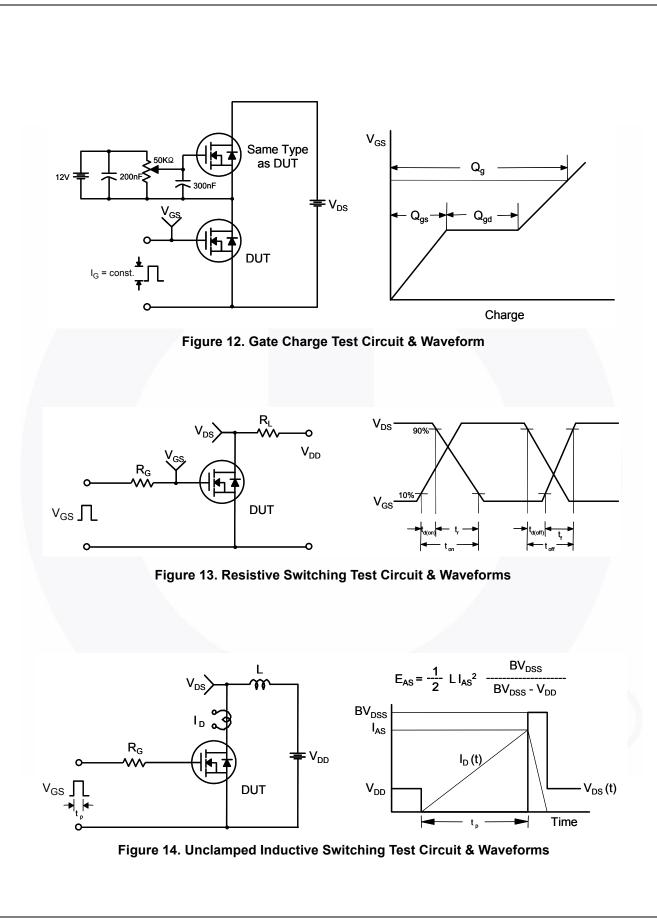
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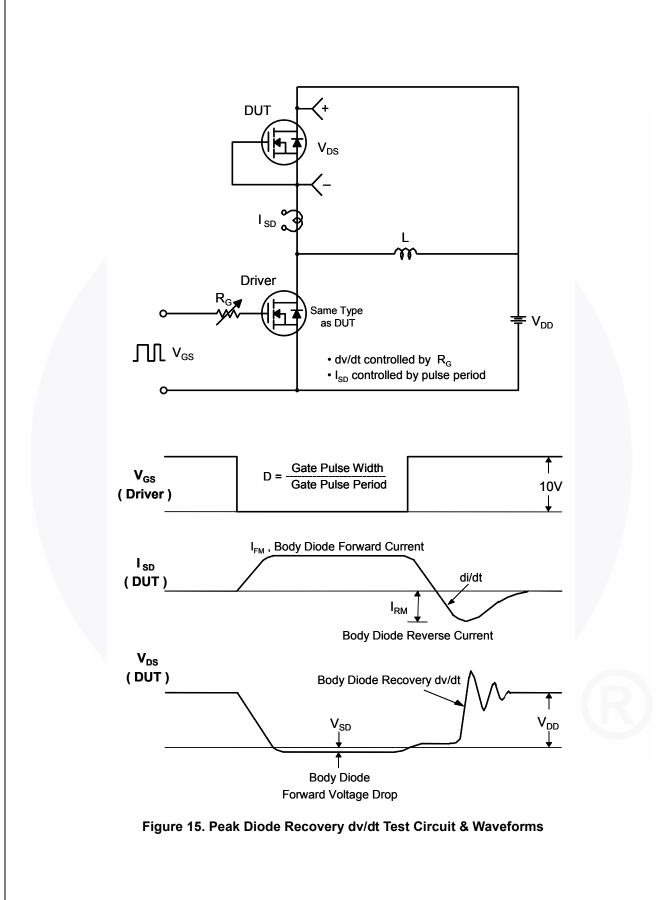
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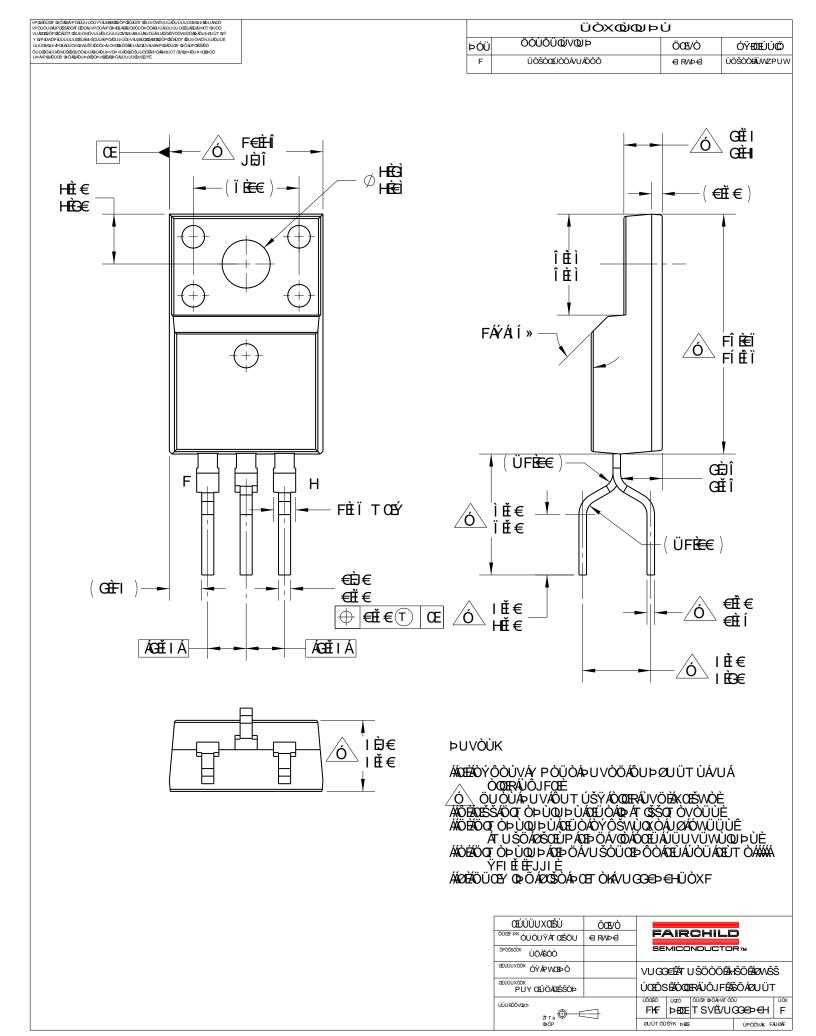


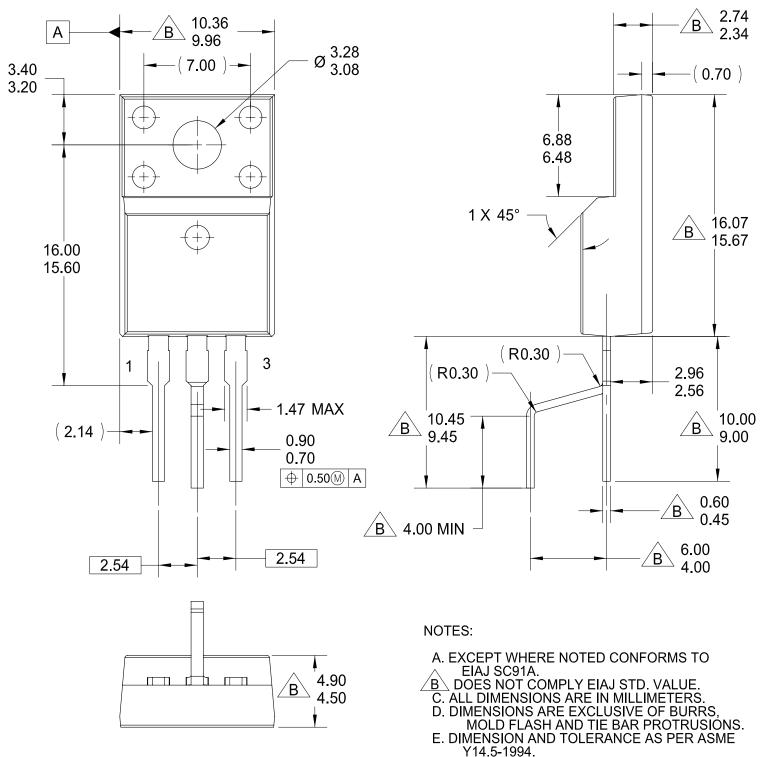


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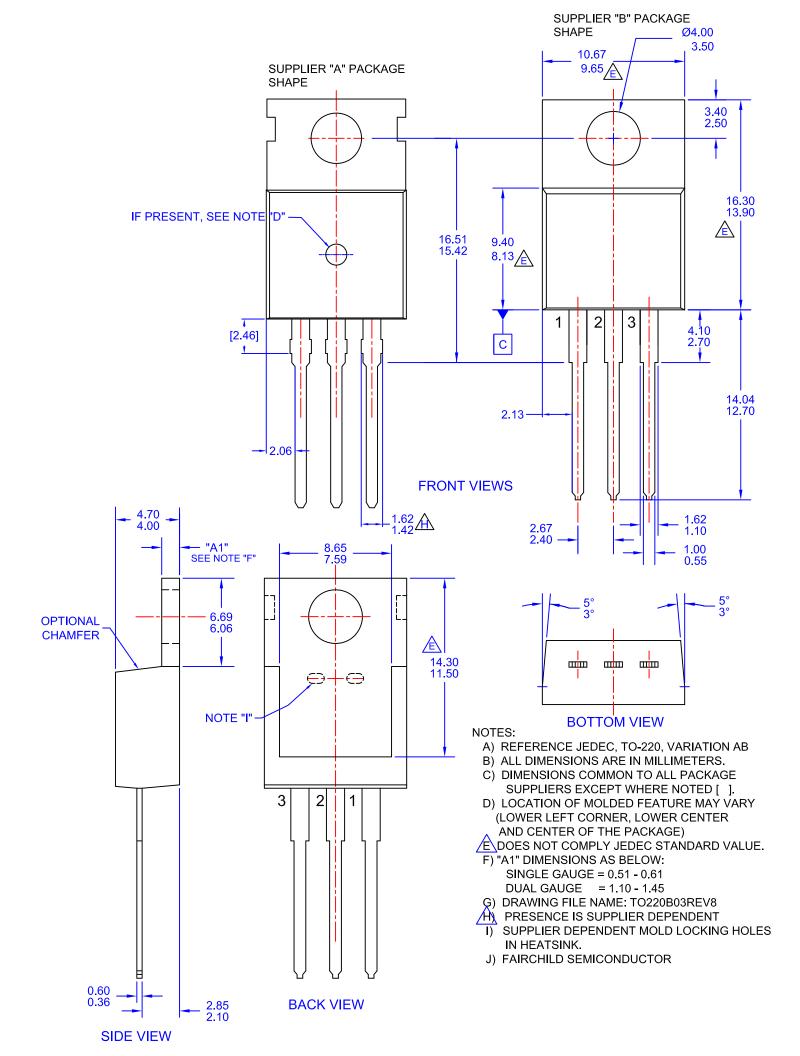
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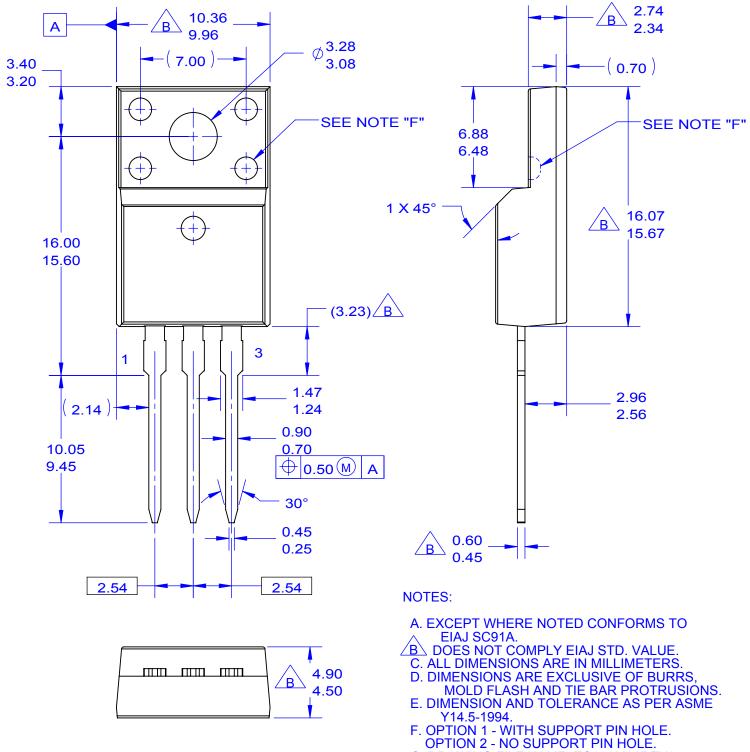




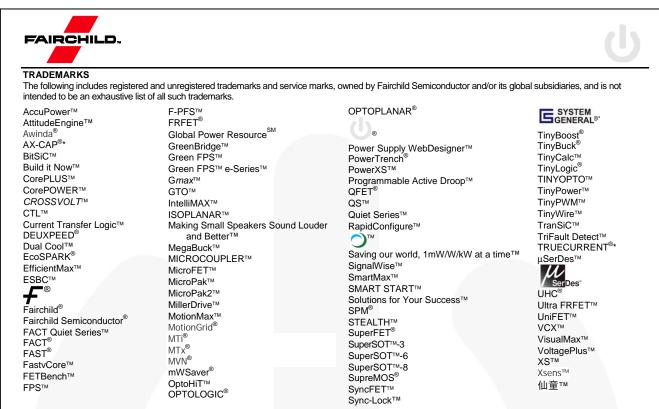


F. DRAWING FILE NAME: TO220Q03REV1





- G. DRAWING FILE NAME: TO220M03REV3



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